
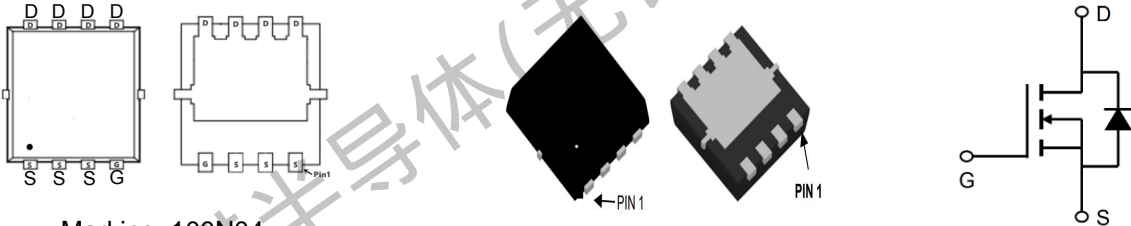


TM100N04NF

N-Channel Enhancement Mosfet

<p><b>General Description</b></p> <ul style="list-style-type: none"> <li>• Low <math>R_{DS(ON)}</math></li> <li>• RoHS and Halogen-Free Compliant</li> </ul> <p><b>Applications</b></p> <ul style="list-style-type: none"> <li>• Load switch</li> <li>• PWM</li> </ul>	<p><b>General Features</b></p> <p><math>V_{DS} = 40V</math> <math>I_D = 100A</math></p> <p><math>R_{DS(ON)} = 4.2m\Omega (typ.) @ V_{GS} = 10V</math></p> <p>100% UIS Tested 100% <math>R_g</math> Tested</p> 
--	---

NF:DFN5x6-8L



Marking: 100N04

**Absolute Maximum Ratings** ( $T_c = 25^\circ C$  unless otherwise noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_c = 25^\circ C$	Continuous Drain Current, $-V_{GS} @ -10V^1$	100	A
$I_D @ T_c = 100^\circ C$	Continuous Drain Current, $-V_{GS} @ -10V^1$	65	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	370	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	188	mJ
$P_D @ T_c = 25^\circ C$	Total Power Dissipation <sup>4</sup>	89	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>	---	62	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>1</sup>	---	3.6	$^\circ C/W$

**TM100N04NF**

**N-Channel Enhancement Mosfet**

Electrical Characteristics: ( $T_c=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>Off Characteristics</b>							
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\ \mu A$	40	---	---	V	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS}=0V, V_{DS}=40V$	---	---	1	$\mu A$	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0A$	---	---	$\pm 100$	nA	
<b>On Characteristics<sup>3</sup></b>							
$V_{GS(th)}$	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\ \mu A$	1.2	2.1	2.8	V	
$R_{DS(on)}$	Drain-Source On Resistance <sup>2</sup>	$V_{GS}=10V, I_D=20A$	---	4.2	5.1	m $\Omega$	
		$V_{GS}=4.5V, I_D=10A$	---	5.3	6.8		
$G_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=2A$	---	16.5	---	S	
<b>Dynamic Characteristics<sup>4</sup></b>							
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1MHz$	---	3400		pF	
$C_{oss}$	Output Capacitance		---	520			
$C_{riss}$	Reverse Transfer Capacitance		---	150			
<b>Switching Characteristics<sup>4</sup></b>							
$t_{d(on)}$	Turn-On Delay Time 3, 4	$V_{DD}=15V, I_D=1A, R_G=3.3\Omega$	---	14.2		ns	
$t_r$	Rise Time 3, 4		---	18.3		ns	
$t_{d(off)}$	Turn-Off Delay Time 3, 4		$V_{GS}=10V$	---	38.8		ns
$t_f$	Fall Time 3, 4			---	13.9		ns
$Q_g$	Total Gate Charge 3, 4	$V_{GS}=4.5V, V_{DS}=32V, I_D=10A$	---	25		nC	
$Q_{gs}$	Gate-Source Charge 3, 4 3, 4		---	6.4		nC	
$Q_{gd}$	Gate-Drain "Miller" Charge 3, 4		---	12.1		nC	
<b>Drain-Source Diode Characteristics</b>							
Symbol	Parameter	Conditions	Min	Typ	Max	Units	
$V_{SD}$	Source-Drain Diode Forward Voltage <sup>3</sup>	$V_{GS}=0V, I_S=1A$	---	---	1	V	
<b>LS</b>	Continuous Source Current	$V_G=V_D=0V$ , Force Current	---	---	100	A	
<b>LSM</b>	Pulsed Source Current		---	---	180	A	

**Notes:**

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.



TM100N04NF

N-Channel Enhancement Mosfet

Typical Characteristics

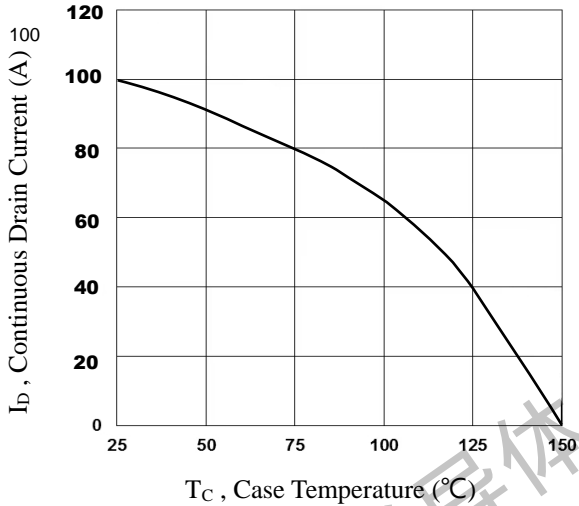


Fig.1 Continuous Drain Current vs. T<sub>C</sub>

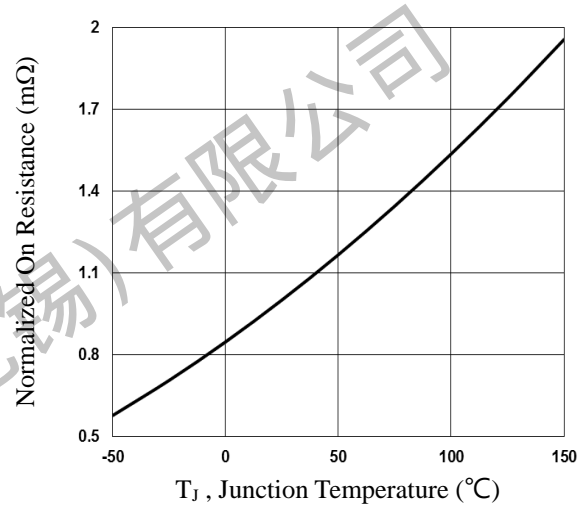


Fig.2 Normalized R<sub>DS(on)</sub> vs. T<sub>J</sub>

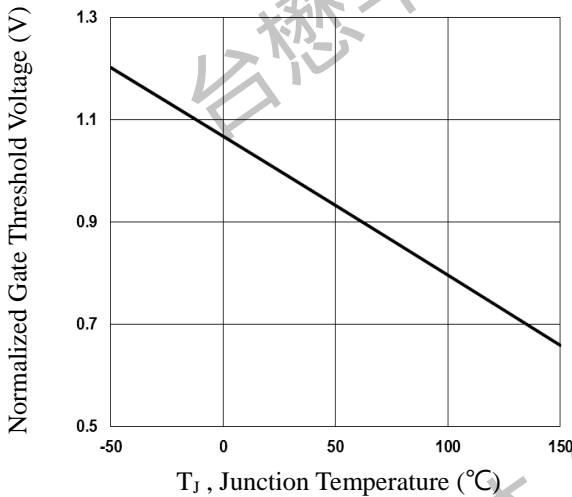


Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>

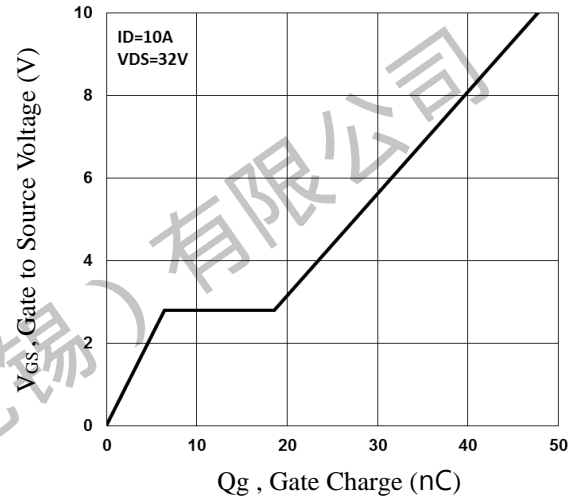


Fig.4 Gate Charge Waveform

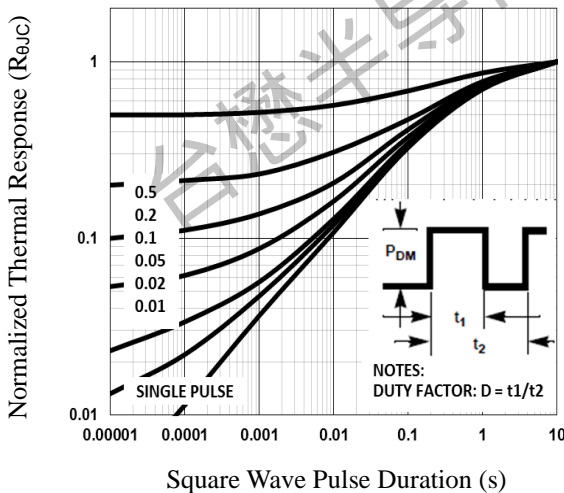


Fig.5 Normalized Transient Impedance

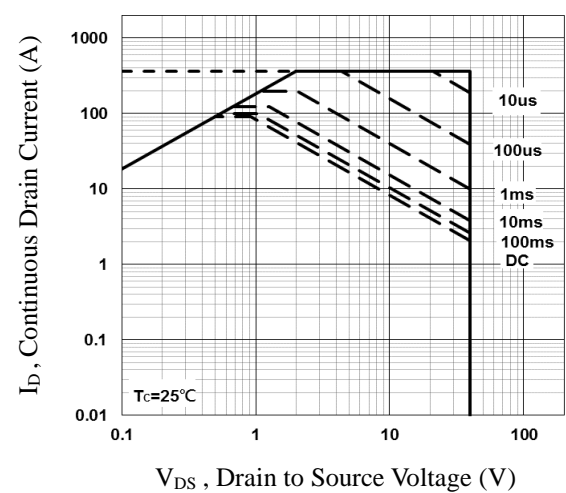
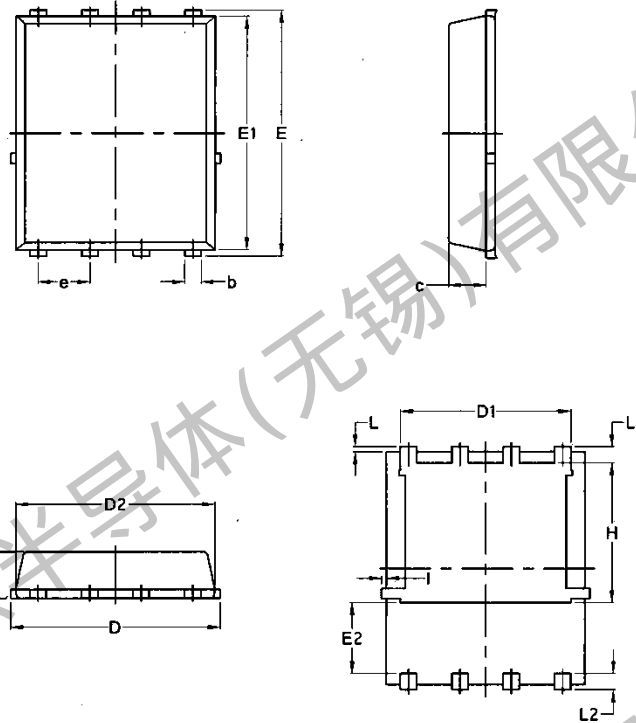


Fig.6 Maximum Safe Operation Area

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Package Mechanical Data:DFN5x6-8L



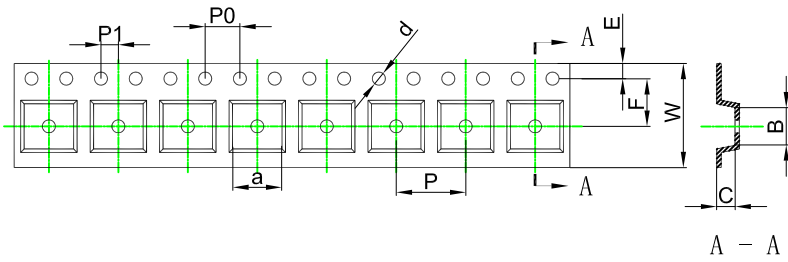
Symbol	Common			
	mm		Inch	
	Min	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070



**TM100N04NF**

**N-Channel Enhancement Mosfet**

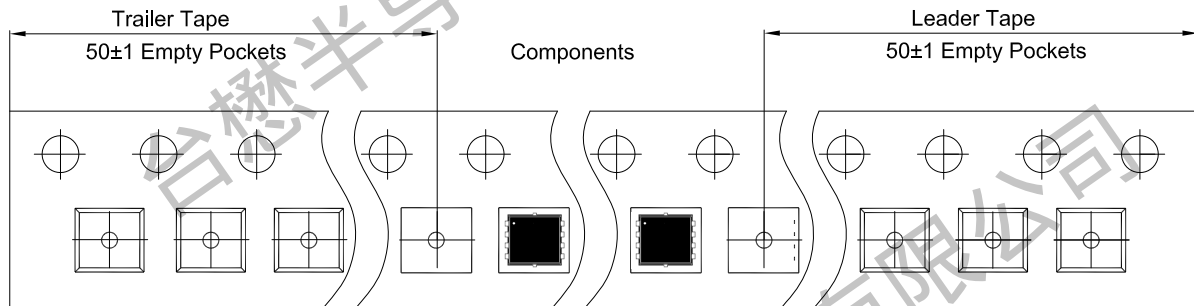
PDFN5x6-8L Embossed Carrier Tape



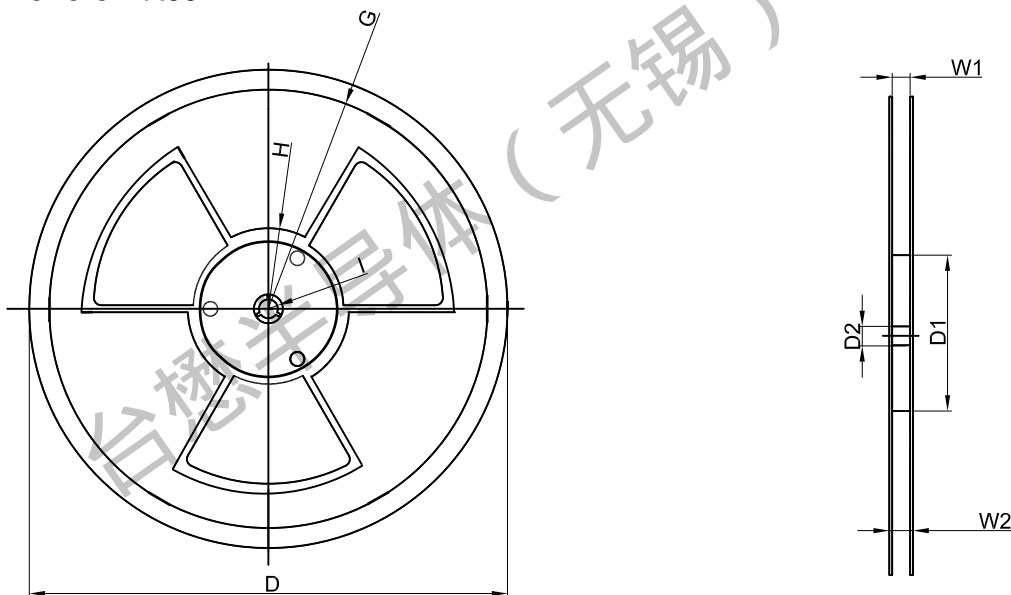
**Packaging Description:**  
SOP-8L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 2,500 units per 13" or 33cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).  
**ALL DIM IN mm**

Dimensions are in millimeter										
Pkg type	a	B	C	d	E	F	P0	P	P1	W
PDFN5x6-8L	6.40	5.40	2.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

PDFN5x6-8L Tape Leader and Trailer



PDFN5x6-8L Reel



Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
13"Dia	Ø330.00	100.00	13.00	R135.00	R55.00	R6.50	12.00	14.00

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
5,000 pcs	13 inch	10,000 pcs	370×355×52	50,000 pcs	400×360×368	



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Revision history:

Date	Rev	Description	Page
2024.05.14	24.05	Original	